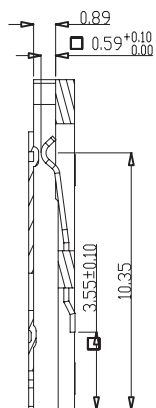
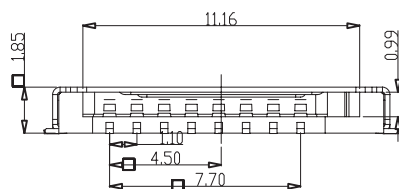
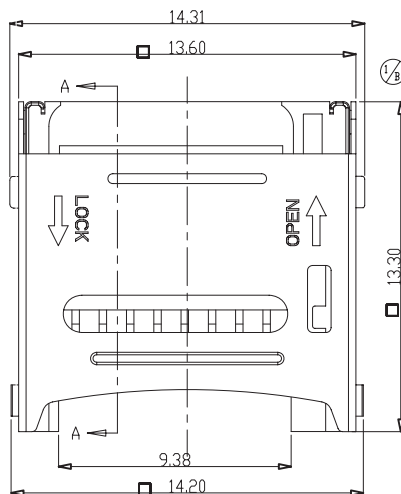
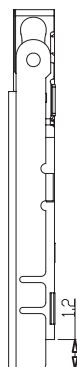


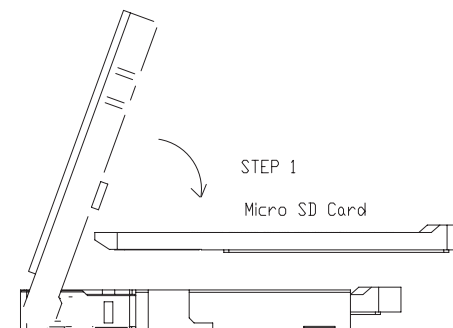
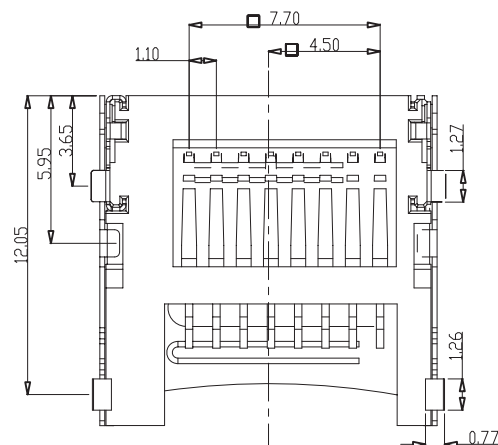
RoHS Compliant



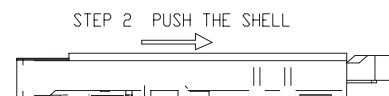
SLIDE SHELL OPEN



SLIDE SHELL LOCK



PUT THE CARD TO RIGHT POSITION AND ROTATE THE SHELL



STEP 3 FINISH



NOTES:

(1)MATERIAL:

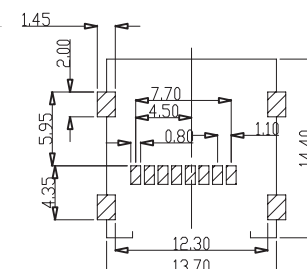
- 1-1 PLASTICS : HEAT RESISTANCE POLYMER,UL94V-0,COLOR:BLACK
- 1-2 CONTACT :PHOSPHOR BRONZE C5191-EH
- 1-3 SHELL : STAINLESS STEEL SUS304-3/4H
- 1-4 TAB:PHOSPHOR BRONZE C5191-H

(2)PLATING:

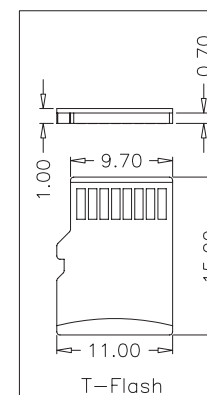
- 2-1 CONTACT :
- 2-1-1 CONTACT AREA : Au PLATING OVER Ni
- 2-1-2 SOLDER TAIL AREA : MATTE TIN PLATING OVER Ni
- 2-2 TAB:MATTE TIN PLATING OVER NICKEL

(3)CONTACT AND TAIL COPLANARITY TO BE 0.15mm MAX.

(4)COPLANARITY SPEC FOR ALL SOLDER TAILS AND SOLDER PADS IS 0.08mm MAX



RECOMMENDED PCB PATTERN LAYOUT
GENERAL TOLERANCE:±0.05
SCALE 2:1



T-Flash

6					PART NAME	MICRO SD CARD SOCKET	*LVE* LAKE-VIEW ELECTRONICS CO., LTD.			
5					PART No.	TFS3-FI-GS				
4					DESIGNER	YAOFEI WANG	VIEW		UNIT	mm
3					CHECKED BY	DELIANG LIU	VER	1.0	ANGLES	±2°
2					APPROVED BY	DAVID CHEN	SHEET	1 OF 11	TOLERANCE	30≤L ±0.50
1							DATE	'10.5.16		10≤L≤30 ±0.40
NO.	DESCRIPTION	QTY	MATERIAL	PLATING						L≤10 ±0.25